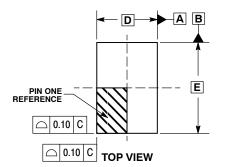
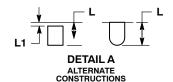


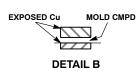


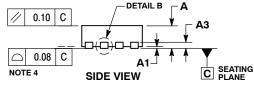
WDFN8 2x3, 0.5P CASE 511BY **ISSUE O**

DATE 03 JUL 2013

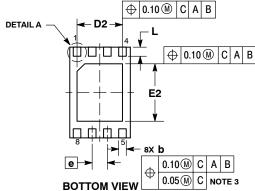












NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED
 TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.25MM FROM THE TERMINAL TIP.
 COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
Α	0.70	0.80
A1	0.00	0.05
А3	0.20 REF	
b	0.20	0.30
D	2.00 BSC	
D2	1.40	1.60
E	3.00 BSC	
E2	1.80	2.00
е	0.50 BSC	
L	0.25	0.35
L1		0.15

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Location

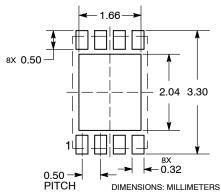
WL = Wafer Lot Υ = Year W = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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